

Features

- 1.3V maximum dropout at full load current
- Fast transient response
- Output current limiting for each channel •
- Built-in thermal shutdown for each channel
- Good noise rejection
- Dual output ch1 = 3.3V, ch2 = 2.5V
- (ch2 = 1.8V for version B)SOP-8L: Available in "Green" Molding Compound
- (No Br, Sb) Lead Free Finish/ RoHS Compliant (Note 1)

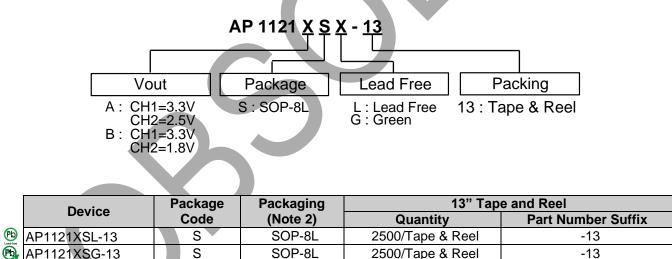
General Description

AP1121 is a low dropout positive regulator which provides 1A output current capability. The product is specifically designed to provide well-regulated supply for low voltage IC applications such as high-speed bus termination and low current 3.3V/2.5V or 3.3V/1.8V logic supply. AP1121 is guaranteed to have <1.3V dropout at full load current making it ideal to provide well regulated outputs dual channels with up to 18V input supply.

Applications

- PC peripheral
- Communication

Ordering Information



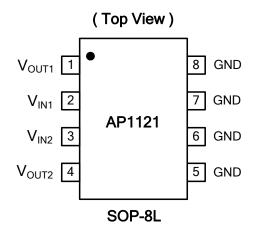
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1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at Notes: com/products/lead_free.htm

2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be on found our website at http://www.diodes.com/datasheets/ap02 01.pdf



Pin Assignments

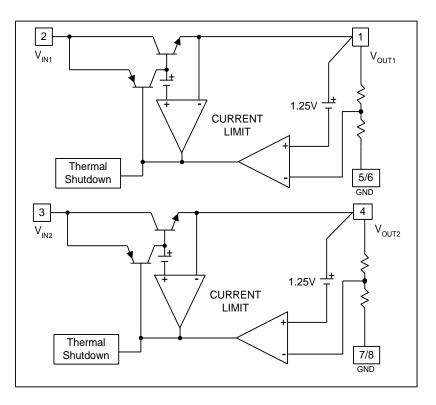


Pin Descriptions

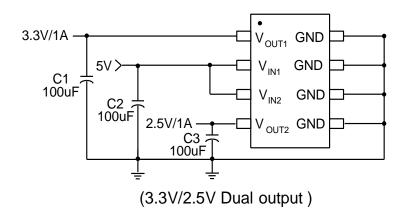
Pin Name	Descriptions			
GND	Ground			
3.3V(V _{OUT1})	The output of the regulator. A minimum of 10uF capacitor (0.15 $\Omega \leq \text{ESR} \leq 20\Omega$) must be			
2.5V/1.8V (V _{OUT2})	connected from this pin to ground to insure stability.			
V _{IN}	The input pin of regulator. Typically a large storage capacitor $(0.15\Omega \le \text{ESR} \le 20\Omega)$ is connected from this pin to ground.			



Block Diagram



Typical Application Circuit





Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V _{IN}	DC Supply Voltage	-0.3 to 18 V	V
T _{ST}	Storage Temperature	-65 to +150	°C
T _{OP}	Operating Junction Temperature Range	0 to +125	°C
T _M	Maximum Junction Temperature	150	οC

Electrical Characteristics (Under Operating Conditions)

Parameter	Conditions		Min	Тур.	Max	Unit
	AP1121 V _{OUT1}	$I_{OUT} = 10$ mA, $T_A = 25^{\circ}$ C, 4.8V $\leq V_{IN} \leq 12$ V	3.235	3.300	3.365	V
Output Voltage	AP1121A - V _{OUT2}	$I_{OUT} = 10$ mA, $T_A = 25^{\circ}$ C, 4V \leq V _{IN} \leq 12V	2.450	2.500	2.550	V
	AP1121B - V _{OUT2}	$I_{OUT} = 10$ mA, $T_A = 25^{\circ}$ C, 4V \leq V _{IN} \leq 12V	1.764	1.800	1.836	V
Line Regulation	$I_0 = 10 \text{mA}, V_{OUT} + 1.5$			0.2	%	
Lood Degulation	AP1121 series V _{OUT1}	V _{IN} = 5V, 0≤I _{OUT} ≤1A, T _A = 25°C (Note 3, 4)		26	33	mV
Load Regulation	AP1121 series V _{OUT2}	$V_{IN} = 4V, 0mA < Io < 1A, T_A = 25^{\circ}C$ (Note 4, 5)		20	25	mV
Dropout Voltage (V _{IN} -V _{OUT})	$I_{OUT} = 1A, \Delta V_{OUT} = 0.1\% V_{OUT}$			1.3	1.4	V
Current Limit	$(V_{IN}-V_{OUT}) = 5V$	1. 1			Α	
Minimum Load Current 0°C≤Tj≤125°C (Note 5)				5	10	mA
Thermal Regulation $T_A = 25 ^{\circ}C$, 30r				0.008	0.04	%/W
Ripple Rejection	F = 120Hz, C_{OUT} = 25uF Tantalum, I_{OUT} = 1A			60	70	dB
Temperature Stability	$I_0 = 10 \text{mA}$		0.5		%	
$\theta_{\rm JA}$ Thermal Resistance Junction-to-Ambient (No heat sink; No air flow)				177 158		^o C/W
$\theta_{\rm JC}$ Thermal Resistance Junction-to-Case	SOP-8L: Control Circ (Note 6) CH1 or CH2 only CH1 & CH2 and PD1		29 19		^o C/W	

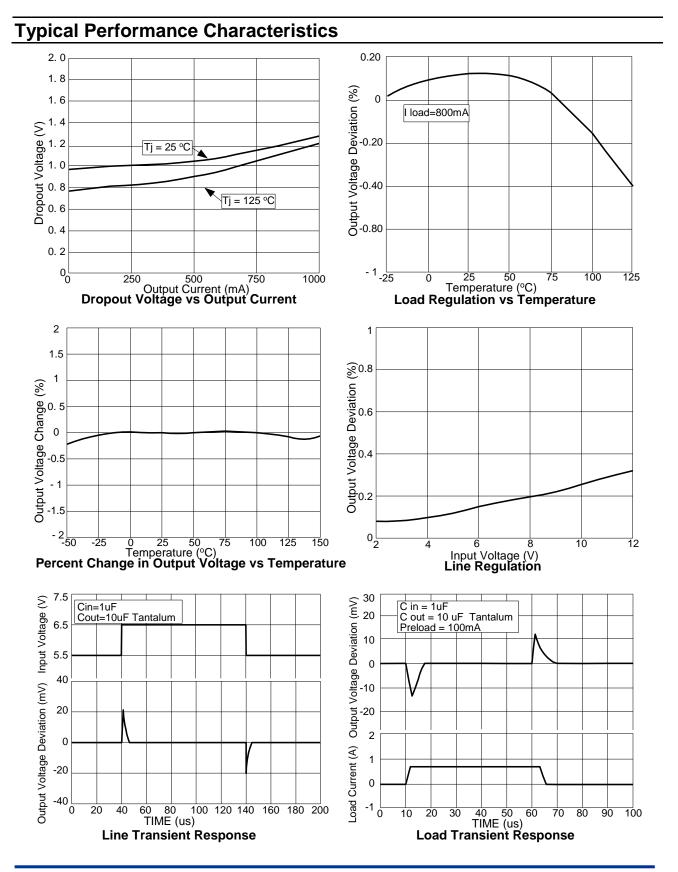
 See thermal regulation specifications for changes in output voltage due to heating effects. Line and load regulation are measured at a constant junction temperature by low duty cycle pulse testing. Load regulation is measured at the output lead = 1/18" from the package.
Line and load regulation are guaranteed up to the maximum power dissipation of 15W. Power dissipation is determined by the input/output Notes:

differentially and the output current. Guaranteed maximum power dissipation will not be available over the full input/output range.

5. Quiescent current is defined as the minimum output current that requires maintaining regulation. At 12V input/output differential the device is guaranteed to regulate if the output current is greater than 10mA. 6. Vout1 and Vout2 are connected to the PCB copper area 5.5mm*5.5mm separately. If you need large PD or lower Tc & Tj, please connect to

the large copper area >> 5.5mm*5.5mm (like 10mm*10mm).

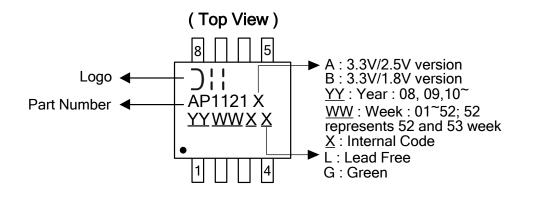






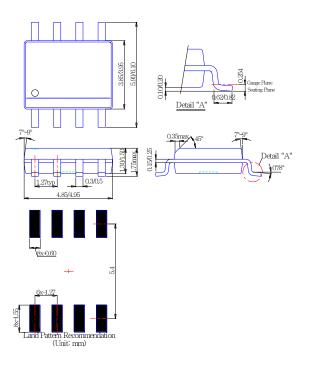
Marking Information

(1) SOP-8L



Package Information

(1) Package type: SOP-8L





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